



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:	§	
Ilya Karpov et al.	§	Art Unit: 2814
	§	
Serial No.: 10/822,361	§	Examiner: Long Pham
	§	
Filed: April 12, 2004	§	Docket: ITL.0835D1US
	§	P14730D
For: Fabricating Deeper and Shallower	§	
Trenches in Semiconductor Structures	§	Assignee: Intel Corporation
	§	

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Sir:

Prior to the receipt of an office action, please amend the above-referenced patent application as follows:

Date of Deposit: August 26, 2005  
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.  
*Cynthia L. Hayden*  
Cynthia L. Hayden